

**COMBINED DECLARATION AND POWER OF ATTORNEY
FOR PATENT APPLICATION**

Attorney Docket ONS00187

As a below named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name.

I believe I am the original, first, and sole inventor (if only one name is listed below), or an original, first, and joint inventor (if plural names are listed below), of the subject matter which is claimed and for which a patent is sought on the invention entitled METHOD FOR MANUFACTURING A HIGH VOLTAGE MOSFET SEMICONDUCTOR DEVICE WITH ENHANCED CHARGE CONTROLLABILITY.

☒ the Patent Application of which is attached hereto, or

☐ the Patent Application of which was filed on _____
as Patent Application No. _____
and was amended on _____.

I hereby state that I have reviewed and understand the contents of the above identified Patent Application, including the claims, and further including any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this Patent Application in accordance with Title 37, Code of Federal Regulations, §1.56.

☐ I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) of foreign application(s) for patent or inventor's certificate(s) listed below and have also identified below foreign application(s) for patent or inventor's certificate(s) having a filing date before that of the Patent Application on which priority is claimed.

Prior Foreign Patent Application(s)

(Number) (Country) (Day/Month/Year Filed)

☐ I hereby claim the benefit under Title 35, United States Code, § 119(e) of United States provisional application(s) listed below.

(Application Number) (Filing Date)

☐ I hereby claim the benefit under Title 35, United States Code, § 120 of United States patent application(s) listed below and, insofar as the subject matter of each of the claims of this Patent Application is not disclosed in the prior United States patent application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this Patent Application.

(Application Number) (Filing Date)

(pending, patented, abandoned)

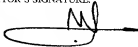
I hereby appoint the following attorney(s) and/or agent(s) of record to prosecute this Patent Application and to transact all business in the U.S. Patent and Trademark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the Patent Application or any patent issued thereon.

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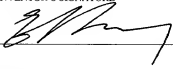
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